

Type	Hits	Search Text	DBs	Time Stamp	Comments
1	BRS 9279	702/22, 23, 24, 27, 28, 30- 36, 40, 56, 57, 60, 64, 65, 81- 84, 99, 104, 113- 119, 124, 126, 130, 132- 134, 138, 183, 184, 189.cc1s.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:07	
2	BRS 5117	700/51, 80, 83, 89, 100, 109, 11 0, 121, 169, 291, 19- 21, 50, 108, 9.cc1s.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 17:06	
3	BRS 5768	438/5, 10, 14, 17.cc1s.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:08	
4	BRS 2355	716/2, 4.cc1s.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:09	
5	BRS 36	(utilit\$3 or consumption\$1 or resource\$1) with fabricat\$3 with process\$3 with tool\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:11	

Type	Hits	Search Text	DBS	Time Stamp	Comments
6	0	(comput\$3 or accumulat\$3 or calculat\$3) with total with (utilit\$3 or consumption\$1 or resource\$1) with fabricat\$3 with process\$3 with tool\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:12	
7	1	(comput\$3 or accumulat\$3 or calculat\$3) with total with (utilit\$3 or consumption\$1 or resource\$1) with (duration\$1 or interval\$1 or period\$1) and fabricat\$3 with process\$3 with tool\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:35	
8	5	(comput\$3 or accumulat\$3 or calculat\$3) with (utilit\$3 or consumption\$1 or resource\$1) with (duration\$1 or interval\$1 or period\$1) and fabricat\$3 with process\$3 with tool\$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:13	

Type	Hits	Search Text	DBs	Time Stamp	Comments
9	5	(comput\$3 or accumulat\$3 or calculat\$3) with (utilit\$3 or consumption\$1 or resource\$1) with (duration\$1 or interval\$1 or period\$1) and fabricat\$3 with process\$3 with tool\$1 and (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:15	
10	5	(comput\$3 or accumulat\$3 or calculat\$3) with (utilit\$3 or consumption\$1 or resource\$1) with (duration\$1 or interval\$1 or period\$1) and fabricat\$3 with process\$3 with tool\$1 and (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) and (input\$1 or output\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:18	

Type	Hits	Search Text	DBs	Time Stamp	Comments
11	BRS 2	"20020055801"	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:19	
12	BRS 1	total with (comput\$3 or accumulat\$3 or calculat\$3) with (utilit\$3 or consumption\$1 or resource\$1) with (duration\$1 or interval\$1 or period\$1) and (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with process\$3 with tool\$1	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:36	
13	BRS 15	(comput\$3 or accumulat\$3 or calculat\$3) with (utilit\$3 or consumption\$1 or resource\$1) with (duration\$1 or interval\$1 or period\$1) and (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with process\$3 with tool\$1	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:43	

Type	Hits	Search Text	DBS	Time Stamp	Comments
14	BRS 16	input\$1 with output\$1 with (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with recipe\$1	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:43	
15	BRS 0	input\$1 with output\$1 with (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with recipe\$1 and resource\$1 with consumption\$1	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:44	
16	BRS 2	input\$1 with output\$1 with (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with recipe\$1 and resource\$1 with consumption\$1	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:44	
17	BRS 2	input\$1 with output\$1 with (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with recipe\$1 and consumption\$1	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:44	

Type	Hits	Search Text	DBs	Time Stamp	Comments
18	BRS 2	input\$1 with output\$1 with (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with recipes\$1 and consumpt\$3 with (time\$1 or period\$1 or duration\$1 or interval\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:45	
19	BRS 7	input\$1 with output\$1 with (semiconductor\$1 or wafer\$1 or integrated adj circuit\$1 or IC\$1 or chip\$1 or die\$1) with recipes\$1 and consumt\$7 with (time\$1 or period\$1 or duration\$1 or interval\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:45	
20	IS&R 6	(("5153837") or ("5586039") or ("5586059") or ("5757673") or ("5801961") or ("6228563") . PN.	USPAT	2005/01/20 16:58	
21	BRS 6	"20010039462" "20020055801" "20020072162"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/20 16:56	

Type	Hits	Search Text	DBs	Time Stamp	Comments
22	BRS 2	"20020156548"	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/01/20 16:57	
23	BRS 0	S21 and S22	US - PGPUB	2005/01/20 16:56	
24	BRS 8	S21 or S22	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/01/20 16:57	
25	IS&R 9	(("5153837") or ("5586039") or ("5586059") or ("5757673") or ("5801961") or ("6228563") or ("6408220") or ("6368975") or ("6496200")).PN.	USPAT	2005/01/20 16:58	
26	BRS 5143	700/51,80,83,89,100,109,11 0,111,121,169,291,19- 21,50,108,9.ccls.	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB	2005/01/20 17:06	